



Notes:
 Rated Voltage : 30V AC/DC
 Rated Current : 1.5A MAX
 Withstand Voltage : 500V AC/minute
 Contact Resistance : 30m?(MAX.)
 Insulation Resistance : 1000M?(MIN.)
 Temperature Range : -55°C~+85°C
 Mating Force : 35N Max
 Mating Force : 10N Min
 Solder Ability:235±5°C,95% Coverage
 Resistance To Soldering Heat:230±5°C,5 Sec
 The product using material and processing must conform to the "WI-PZ-142" HSF technical standard control requirements

NO.	Part Name	Material	Finish/Color	Q'TY
1	Housing	PBT	Black UL94-V0	1
2	Contact	Copper Alloy	Gold Flash Plated on Contact Area 80u" Min.Tin Plated on Solder Tails, 50u" Min.Nickel Under plated Over All.	4
3	Shell	Copper Alloy	50u" Min.Nickel Under plated Over All.	1

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE	NAME	DATE	PART NO.	DWG NO.				
A0	新版发行	15.08.19		LINEAR	ANGLES	1:1	Frey Yang	24.08.25	W-32-0075-0400	ENDE05				
A1	变更公司名称	17.10.13	0.0±0.25	X° REF±6°	APPROVED	Daniel Dong	24.08.25	TITLE USB AF 90度插板铜黑G/F						
A2	依实物更新图纸	24.08.25	0.00±0.15	X° ±3°	DESIGNER	Zhang peng	24.08.25							
			UNIT: MM	0.00±0.08	X° X' ±2°	DRAWN				REV	A2	SHEET	1/1	